

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YOUNGPO LEE	10/15/2020
TAEYOON KIM	10/16/2020
DUKHYUN CHANG	10/15/2020
HYEONGGEON LEE	10/16/2020
CHAIMAN LIM	10/16/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SAMSUNG ELECTRONICS CO., LTD.
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<b>City:</b>	GYEONGGI-DO
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17079927
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<b>ATTORNEY DOCKET NUMBER:</b>	4700-1-316
<b>NAME OF SUBMITTER:</b>	STEVE CHA
<b>SIGNATURE:</b>	/Steve Cha/
<b>DATE SIGNED:</b>	10/26/2020
<b>Total Attachments: 2</b>	
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**Assignment of Invention and Patent Application**

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration,

- 1) Youngpo LEE of 129 Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do  
16677 Republic of Korea
- 2) Taeyoon KIM of 129 Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do  
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- 3) Dukhyun CHANG of 129 Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do  
16677 Republic of Korea
- 4) Hyeonggeon LEE of 129 Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do  
16677 Republic of Korea
- 5) Chaiman LIM of 129 Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do  
16677 Republic of Korea

(hereinafter **Assignor**) hereby sells, assigns, transfers, and sets over unto:

**SAMSUNG ELECTRONICS CO., LTD.** of  
**129 SAMSUNG-RO, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO, 16677**  
**REPUBLIC OF KOREA**

(hereinafter **Assignee**) the entire right, title and interest for the United States Of America and all other countries as defined in 35 U.S.C. Section 261, in and to the invention entitled as:

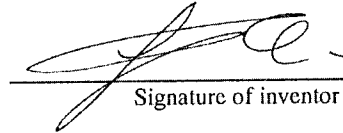
**ELECTRONIC DEVICE DETECTING LOCATION AND METHOD THEREOF**

invented by **Assignor**; the application for United States patent and all other countries, invented by **Assignor**; any patent or reissues of any patent that may be granted thereon; and any applications which are continuations, continuation-in-part, substitutes, or divisions of said application. **Assignor** authorizes **Assignee** to enter the date of signature and/or Serial Number and Filing Date in the above. **Assignor** also authorizes and requests the Commissioner of Patents and Trademarks to issue any resulting patent(s) to the said **Assignee**, for its interests as **Assignee**, its successors, assigns and legal representatives. The undersigned agrees that the attorney of record in said application shall hereafter act on behalf of said **Assignee**; and **Assignor** further conveys to **Assignee** all priority rights resulting from the above-identified application for United States Patent and all other countries. **Assignor** agrees to execute all papers, give any required testimony and perform other lawful acts, as deemed essential by **Assignee** to perfect **Assignee's** interest in any resulting patent of the United

States and all other countries, and to acquire, hold, enforce, convey, and uphold the validity of said patent and reissues and extensions thereof, and Assignee's interest therein.

**SIGNED ON THE DATES(S) INDICATED BESIDE MY/OUR SIGNATURE(S):**

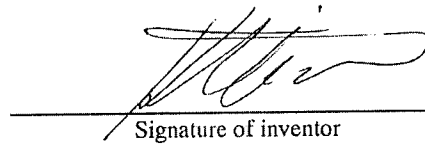
**Name of First Inventor: Youngpo LEE**

  
\_\_\_\_\_  
Signature of inventor

Dated: 15 Oct. 2020

WITNESSED: \_\_\_\_\_

**Name of Second Inventor: Taeyoon KIM**

  
\_\_\_\_\_  
Signature of inventor

Dated: 16 Oct. 2020

WITNESSED: \_\_\_\_\_

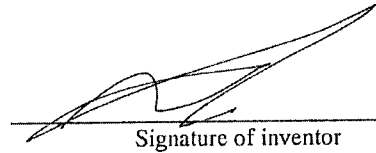
**Name of Third Inventor: Dukhyun CHANG**

Duk Hyun Chang  
\_\_\_\_\_  
Signature of inventor

Dated: 15 Oct. 2020

WITNESSED: \_\_\_\_\_


**Name of Fourth Inventor: Hyeonggeon LEE**

  
\_\_\_\_\_  
Signature of inventor

Dated: 16 Oct 2020

WITNESSED: \_\_\_\_\_

**Name of Fifth Inventor: Chaiman LIM**

  
\_\_\_\_\_  
Signature of inventor

Dated: 16 Oct 2020

WITNESSED: \_\_\_\_\_